## 2SK439

Silicon N-Channel MOS FET

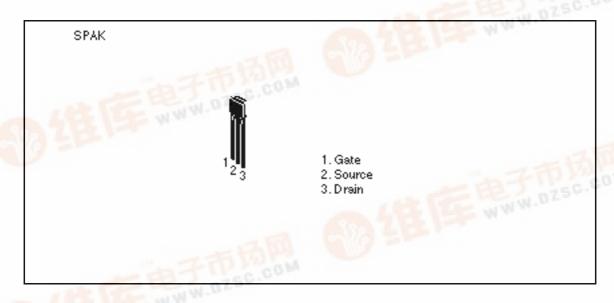
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#### **Application**

DEZG.WWW

VHF amplifier

#### Outline





#### 2SK439

#### **Absolute Maximum Ratings** $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DS</sub>	20	V
Gate to source voltage	$V_{GSS}$	±5	V
Drain current	I <sub>D</sub>	30	mA
Gate current	I <sub>G</sub>	±1	mA
Channel power dissipation	Pch	300	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

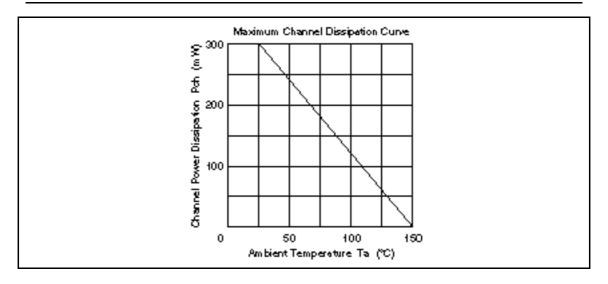
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSX}$	20	_	_	V	$I_D = 100 \ \mu A, \ V_{GS} = -4 \ V$
Gate cutoff current	I <sub>GSS</sub>	_	_	±20	nA	$V_{GS} = \pm 5 \text{ V}, V_{DS} = 0$
Drain current	I <sub>DSS</sub> *1	4	_	12	mA	$V_{DS} = 10 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	0	_	-2.0	V	$V_{DS} = 10 \text{ V}, I_{D} = 10  \mu\text{A}$
Forward transfer admittance	Уfs	8	14	_	mS	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$
Input capacitance	Ciss	_	2.5	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1$ MHz
Reverse transfer capacitance	Crss	_	0.03	_	pF	_
Output capacitance	Coss	_	1.8	_	pF	$V_{DS} = 5 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$
Power gain	PG		30		dB	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$ f = 100 MHz
Noise figure	NF	_	2.0	_	dB	_

Note: 1. The 2SK439 is grouped by I<sub>DSS</sub> as follows.

Grade	D	E	F
I <sub>DSS</sub>	4 to 8	6 to 10	8 to 12

See characteristic curves of 2SK359.

### 2SK439



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